

HEF40098B

3-state hex inverting buffer

Rev. 05 — 31 October 2008

Product data sheet

1. General description

The HEF40098B is a hex inverting buffer with 3-state outputs. The 3-state outputs are controlled by two active LOW enable inputs ($\overline{1OE}$ and $\overline{2OE}$). A HIGH on $\overline{1OE}$ causes four of the six active LOW buffer elements ($\overline{1Y0}$ to $\overline{1Y3}$) to assume a high-impedance or OFF-state regardless of the other input conditions and a HIGH on $\overline{2OE}$ causes the outputs of the remaining two buffer elements ($\overline{2Y0}$ and $\overline{2Y1}$) to assume a high-impedance or OFF-state regardless of the other input conditions.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input. It is also suitable for use over the full industrial ($-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$) temperature range.

2. Features

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Operates across the full industrial temperature range $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$
- Complies with JEDEC standard JESD 13-B
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V

3. Applications

- Industrial

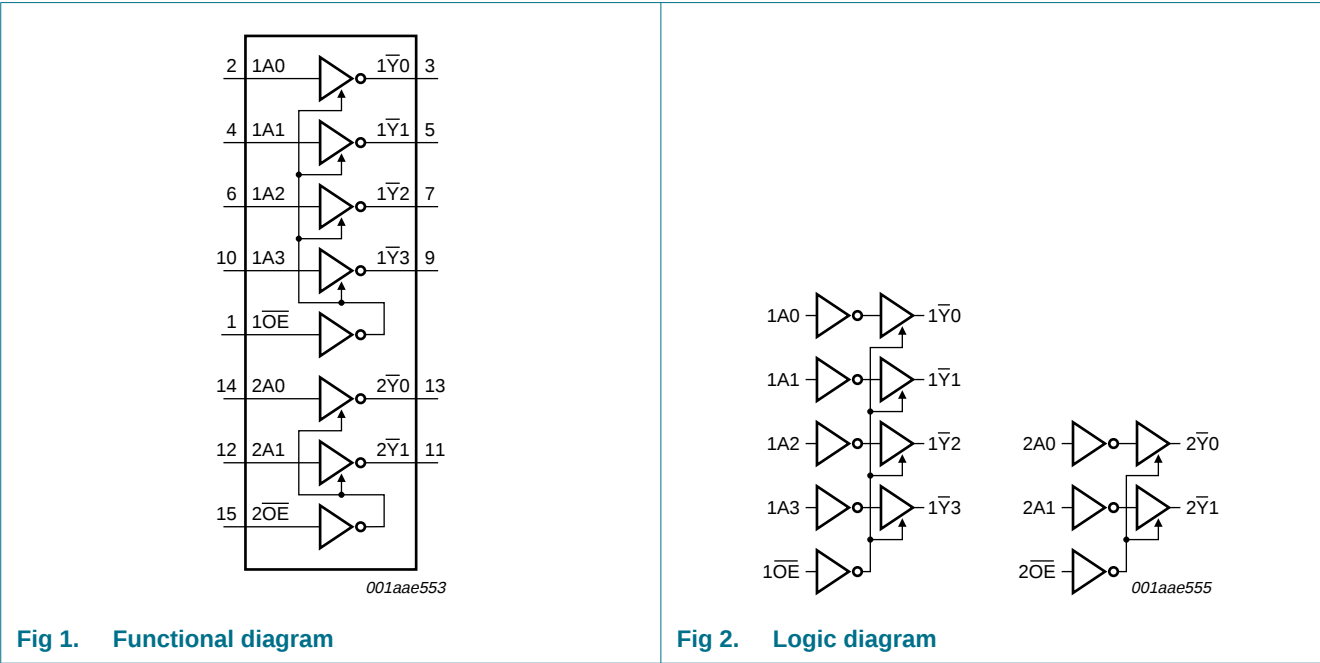
4. Ordering information

Table 1. Ordering information

All types operate from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$

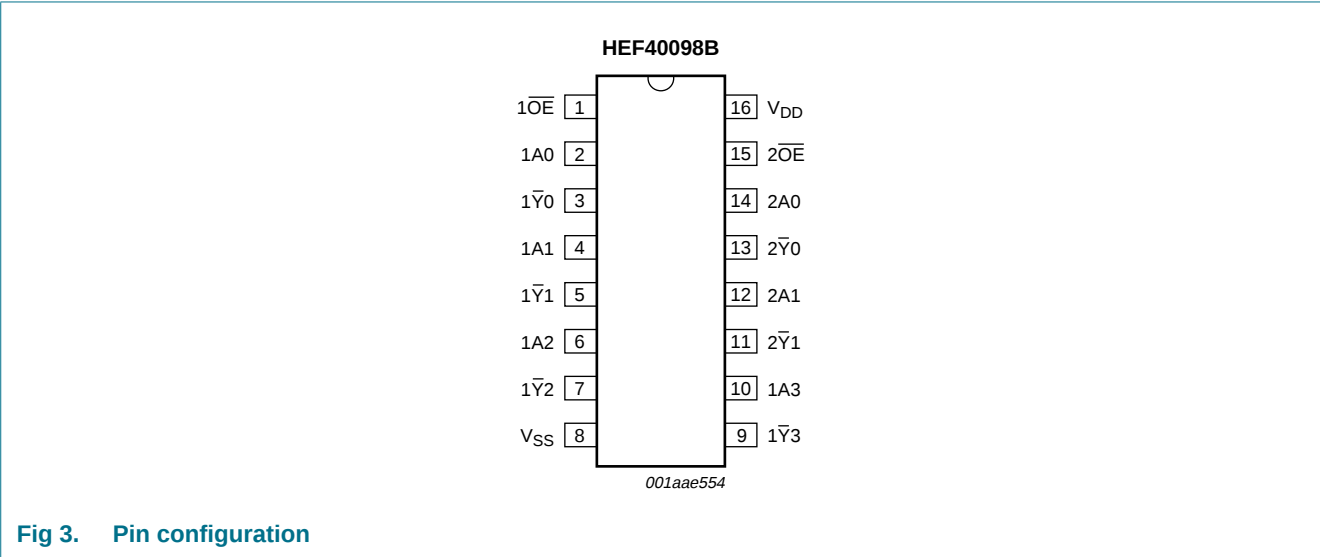
Type number	Package		
	Name	Description	Version
HEF40098BP	DIP16	plastic dual in-line package; 16-leads (300 mil)	SOT38-4
HEF40098BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 $\overline{\text{OE}}$	1	output enable input (active LOW)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 10	buffer input
1 $\overline{\text{Y}}$ 0, 1 $\overline{\text{Y}}$ 1, 1 $\overline{\text{Y}}$ 2, 1 $\overline{\text{Y}}$ 3	3, 5, 7, 9	buffer output (active LOW)
V _{SS}	8	supply voltage
2 $\overline{\text{Y}}$ 0, 2 $\overline{\text{Y}}$ 1	13, 11	buffer output (active LOW)
2A0, 2A1	14, 12	buffer input
2 $\overline{\text{OE}}$	15	output enable input (active LOW)
V _{DD}	16	supply voltage

7. Functional description

Table 3. Function table^[1]

Inputs		Output
nAn	n $\overline{\text{OE}}$	n $\overline{\text{Y}}$ n
H	L	L
L	L	H
X	H	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF state.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	V _I < 0.5 V or V _I > V _{DD} + 0.5 V	-	±10	mA
V _I	input voltage		-0.5	V _{DD} + 0.5	V
I _{OK}	output clamping current	V _O < 0.5 V or V _O > V _{DD} + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	T _{amb} = -40 to +85 °C			
		DIP16 package	^[1] -	750	mW
		SO16 package	^[2] -	500	mW
P	power dissipation		-	100	mW

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DD}	supply voltage		3	-	15	V
V_I	input voltage		0	-	V_{DD}	V
T_{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5\text{ V}$	-	-	3.75	ns/V
		$V_{DD} = 10\text{ V}$	-	-	0.5	ns/V
		$V_{DD} = 15\text{ V}$	-	-	0.08	ns/V

10. Static characteristics

Table 6. Static characteristics

$V_{SS} = 0\text{ V}$; $V_I = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	$T_{amb} = -40\text{ °C}$		$T_{amb} = 25\text{ °C}$		$T_{amb} = 85\text{ °C}$		Unit
				Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$ I_O < 1\text{ }\mu\text{A}$	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$ I_O < 1\text{ }\mu\text{A}$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V_{OH}	HIGH-level output voltage	$ I_O < 1\text{ }\mu\text{A}$	5 V	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V_{OL}	LOW-level output voltage	$ I_O < 1\text{ }\mu\text{A}$	5 V	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I_{OH}	HIGH-level output current	$V_O = 2.5\text{ V}$	5 V	-3.8	-	-3.2	-	-2.5	-	mA
		$V_O = 4.6\text{ V}$	5 V	-1.2	-	-1.0	-	-0.8	-	mA
		$V_O = 9.5\text{ V}$	10 V	-3.8	-	-3.2	-	-2.5	-	mA
		$V_O = 13.5\text{ V}$	15 V	-12.0	-	-10.0	-	-8.0	-	mA
I_{OL}	LOW-level output current	$V_O = 0.4\text{ V}$;	4.75 V	3.5	-	2.9	-	2.3	-	mA
		$V_O = 0.5\text{ V}$;	10 V	12.0	-	10.0	-	8.0	-	mA
		$V_O = 1.5\text{ V}$;	15 V	24.0	-	20.0	-	16.0	-	mA
I_I	input leakage current	$V_I = 0\text{ V}$ or 15 V	15 V	-	0.3	-	0.3	-	1.0	μA
I_{DD}	supply current	$I_O = 0\text{ A}$	5 V	-	4	-	4	-	30	μA
			10 V	-	8	-	8	-	60	μA
			15 V	-	16	-	16	-	120	μA
I_{OZ}	OFF-state output current		15 V	-	1.6	-	1.6	-	12.0	μA
C_I	input capacitance			-	-	-	7.5	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

$V_{SS} = 0\text{ V}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$; for test circuit see [Figure 6](#); unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula ^[1]	Min	Typ	Max	Unit
t_{PHL}	HIGH to LOW propagation delay	nAn to nYn; see Figure 4	5 V	$70\text{ ns} + (0.20\text{ ns/pF}) C_L$	-	80	160	ns
			10 V	$31\text{ ns} + (0.08\text{ ns/pF}) C_L$	-	35	70	ns
			15 V	$22\text{ ns} + (0.06\text{ ns/pF}) C_L$	-	25	50	ns
t_{PLH}	LOW to HIGH propagation delay	nAn to nYn; see Figure 4	5 V	$50\text{ ns} + (0.30\text{ ns/pF}) C_L$	-	65	130	ns
			10 V	$24\text{ ns} + (0.13\text{ ns/pF}) C_L$	-	30	60	ns
			15 V	$23\text{ ns} + (0.05\text{ ns/pF}) C_L$	-	25	50	ns
t_{THL}	HIGH to LOW output transition time	see Figure 4	5 V	$15\text{ ns} + (0.30\text{ ns/pF}) C_L$	-	30	60	ns
			10 V	$10\text{ ns} + (0.11\text{ ns/pF}) C_L$	-	15	30	ns
			15 V	$7\text{ ns} + (0.07\text{ ns/pF}) C_L$	-	10	20	ns
t_{TLH}	LOW to HIGH output transition time	see Figure 4	5 V	$10\text{ ns} + (0.50\text{ ns/pF}) C_L$	-	35	70	ns
			10 V	$8\text{ ns} + (0.24\text{ ns/pF}) C_L$	-	20	40	ns
			15 V	$6\text{ ns} + (0.18\text{ ns/pF}) C_L$	-	15	30	ns
t_{PHZ}	HiGH to OFF-state propagation delay	$\overline{nOE}$, to nYn; see Figure 5	5 V		-	45	85	ns
			10 V		-	35	65	ns
			15 V		-	30	60	ns
t_{PLZ}	LOW to OFF-state propagation delay	$\overline{nOE}$, to nYn; see Figure 5	5 V		-	65	135	ns
			10 V		-	40	80	ns
			15 V		-	35	70	ns
t_{PZH}	OFF-state to HIGH propagation delay	$\overline{nOE}$, to nYn; see Figure 5	5 V		-	70	140	ns
			10 V		-	35	75	ns
			15 V		-	30	65	ns
t_{PZL}	OFF-state to LOW propagation delay	$\overline{nOE}$, to nYn; see Figure 5	5 V		-	90	185	ns
			10 V		-	40	85	ns
			15 V		-	35	70	ns

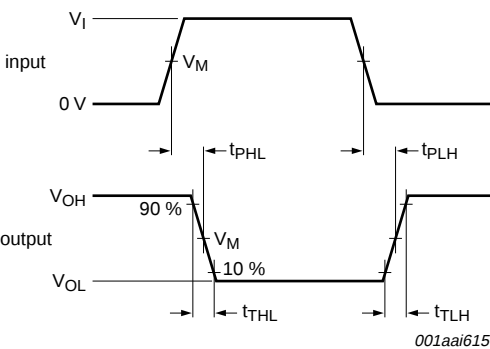
[1] The typical value of the propagation delay and transition times are calculated from the extrapolation formula as shown (C_L in pF).

Table 8. Dynamic power dissipation P_D

P_D can be calculated (in μW) from the formulas shown. $V_{SS} = 0\text{ V}$; $t_r = t_f \leq 20\text{ ns}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$.

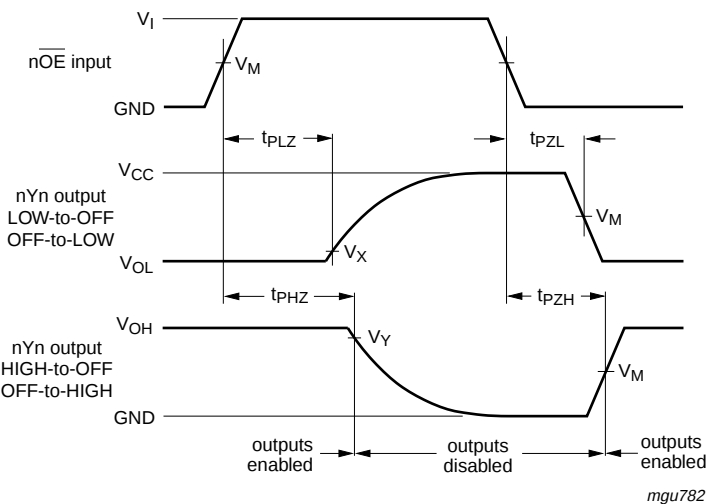
Symbol	Parameter	V_{DD}	Typical formula for P_D (μW)	where:
P_D	dynamic power dissipation	5 V	$P_D = 5000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz,
		10 V	$P_D = 22800 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	f_o = output frequency in MHz,
		15 V	$P_D = 81000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$	C_L = output load capacitance in pF, V_{DD} = supply voltage in V, $\Sigma(C_L \times f_o)$ = sum of the outputs.

12. AC waveforms



Measurement points are given in [Table 9](#), V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 4. Input (nAn) to output (nYn) propagation delays

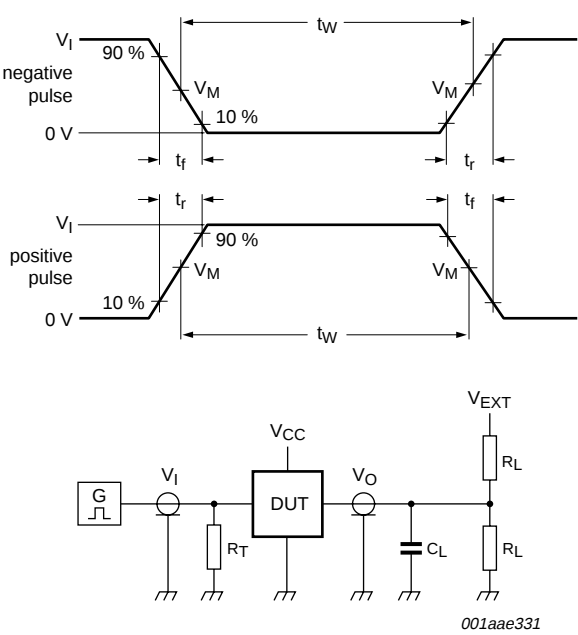


Measurement points are given in [Table 9](#), V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. 3-state enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output		
V_{DD}	V_M	V_M	V_X	V_Y
5 V to 15 V	$0.5V_{DD}$	$0.5V_{DD}$	$0.1V_{DD}$	$0.9V_{DD}$



Test data is given in [Table 10](#).
Definitions for test circuit:
 R_L = Load resistance;
 C_L = Load capacitance including jig and probe capacitance;
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;
 V_{EXT} = External voltage for measuring switching times.

Fig 6. Test circuitry for switching times

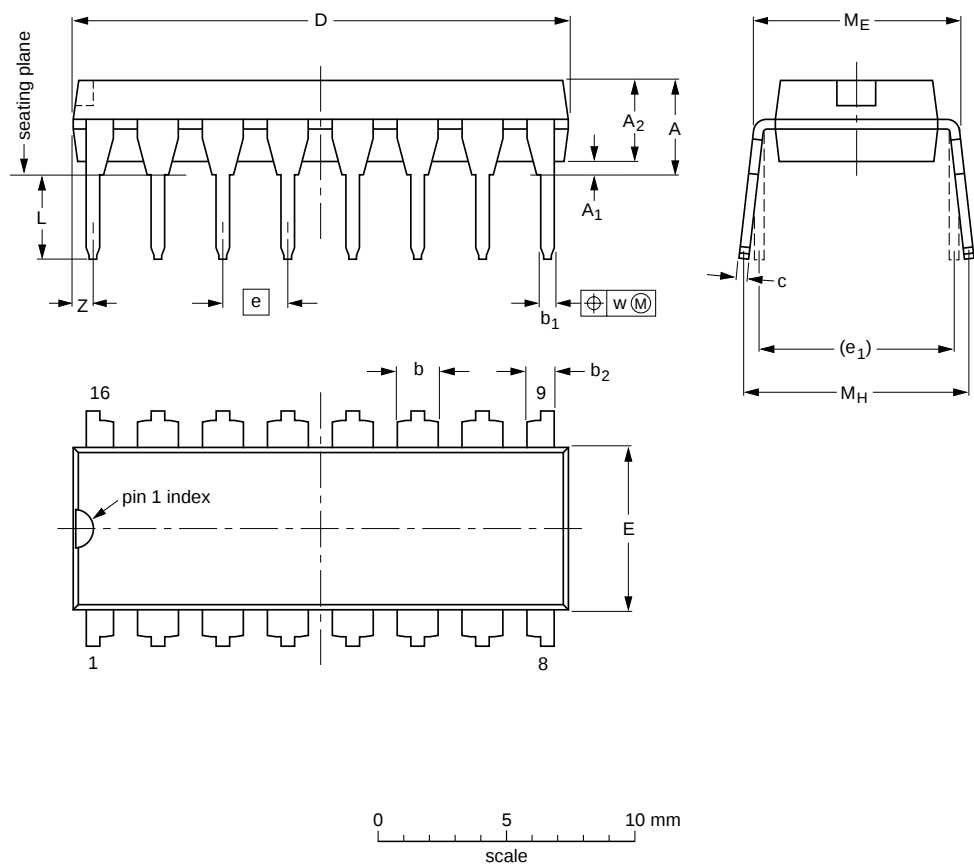
Table 10. Test data

Supply voltage	Input		Load		V_{EXT}		
	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ}, t_{PZH}
5 V to 15 V	V_{DD}	≤ 20 ns	50 pF	1 k Ω	open	$2V_{DD}$	GND

13. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

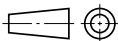
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT38-4						95-01-14- 03-02-13

Fig 7. Package outline SOT38-4 (DIP16)

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

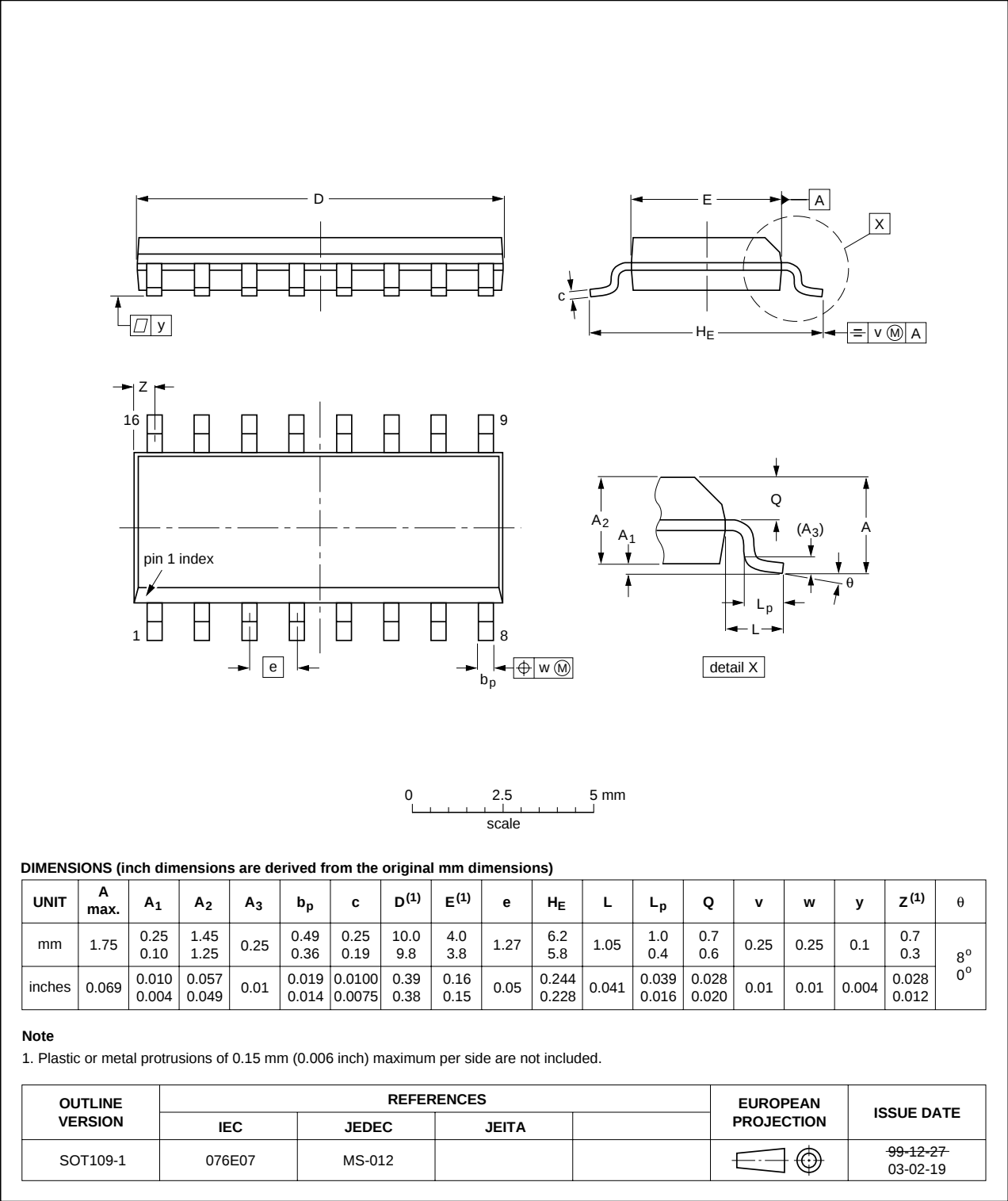


Fig 8. Package outline SOT109-1 (SO16)

14. Abbreviations

Table 11. Abbreviations

Acronym	Description
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF40098B_5	20081031	Product data sheet	-	HEF40098B_4
Modifications:	- Maximum T_{amb} changed to 85 °C and $T_{amb} = 125$ °C parameter data removed throughout the data sheet. Section 1 "General description" temperature range statement modified. Section 10 "Static characteristics" I_I, I_{DD} and I_{OZ} values updated.			
HEF40098B_4	20080731	Product data sheet	-	HEF40098B_CNV_3
HEF40098B_CNV_3	19950101	Product specification	-	HEF40098B_CNV_2
HEF40098B_CNV_2	19950101	Product specification	-	-

16. Legal information

16.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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